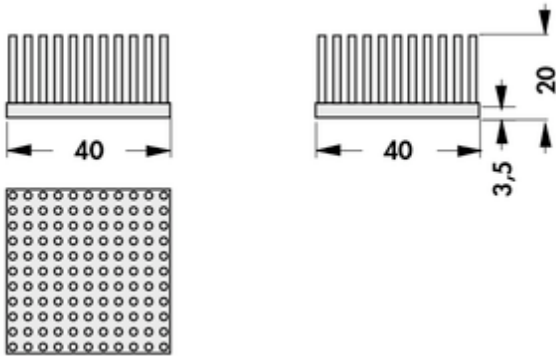
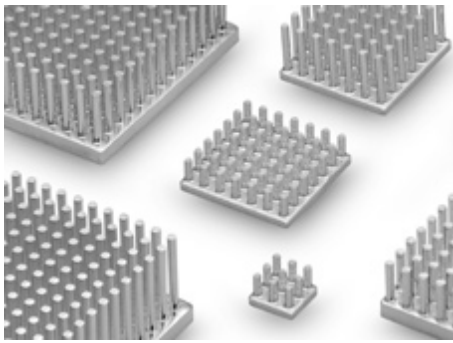
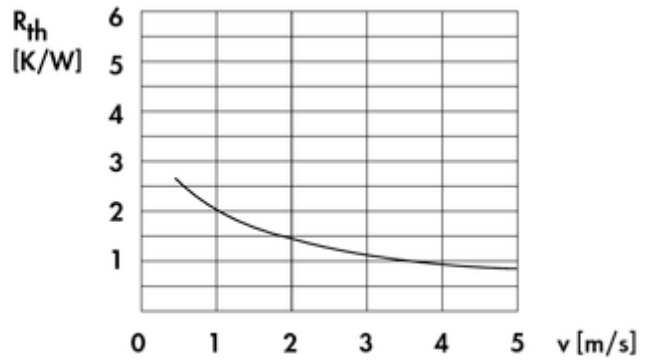


Pin heatsinks / **ICK S 40 x 40 x 20**



40 x 40 x 20 mm, pin heatsinks quadratic



Parameters of article ICK S 40 x 40 x 20

Bauform	Rechteck
R_{th} [K/W]	3.5
dissipation loss [W]	21.4
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
width [mm]	40
height [mm]	20
plate thickness [mm]	3.5
weight [g]	29
length on stock [mm]	40

Accessories/ related articles

Thermally conductive foil both sides adhesive / **WLFT 404 40 x 40**

Thermally conductive foil both sides adhesive / **WLFT 405 40 x 40**